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Contents

ix *Authors*
xiii *Conference Committee*

CRYOGENIC COOLING OF SENSING DEVICES 2019: COOLER DESIGN

11002 02 **FLIR FL-100 miniature linear Stirling cryocooler development summary** [11002-1]

11002 03 **Low cost cryogenic coolers for commercial infrared imagers** [11002-2]

11002 04 **Qualification of Northrop Grumman MicroCooler to TRL6** [11002-4]

CRYOGENIC COOLING OF SENSING DEVICES 2019: COOLER APPLICATIONS

11002 07 **Ruggedized Dewar design and construction for rocket launch survival** [11002-7]

11002 08 **Theoretical and experimental analysis of Dewar thermal properties** [11002-8]

11002 09 **Update on AIM HOT cooler developments** [11002-9]

11002 0A **Optimized tuning of RMs1 for wide range of applications** [11002-10]

T2SL I

11002 0B **ALD-Al_2O_3 passivation effects on surface characteristics of InAs/GaSb type-II superlattice infrared photodetectors** [11002-11]

11002 0C **Industrialization of type-II superlattice infrared detector technology at Fraunhofer IAF** [11002-12]

11002 0D **Resonant-cavity infrared detectors with high quantum efficiency and very thin absorbers at 4.0 µm (Invited Paper)** [11002-13]

11002 0E **Residual fixed pattern noise and random telegraph signal noise of a MWIR T2SL focal plane array** [11002-14]

11002 0F **The emergence of InAs/InAsSb type-II strained layer superlattice barrier infrared detectors (Invited Paper)** [11002-15]

11002 0G **Antimonite-based gap-engineered type-II superlattice materials grown by MBE and MOCVD for the third generation of infrared imagers (Invited Paper)** [11002-16]

T2SL II

11002 0M **GaSb-based infrared photodetector structures grown on Ge-Si substrates via metamorphic buffers (Invited Paper)** [11002-22]

11002 0N **T2SL mid- and long-wave infrared photodetector structures grown on (211)B and (311)A GaSb substrates (Invited Paper)** [11002-23]

11002 0O **Increasing throughput and quality of large area GaSb substrates used in infrared focal plane array production** [11002-24]

11002 0P **Chemomechanical polishing methods and surface metrology of cadmium zinc telluride substrates suitable for IRFPA production** [11002-25]

MONDAY PLENARY SESSION

11002 0Q **Clinical virtual reality in mental health and rehabilitation: A brief review of the future! (Plenary Paper)** [11002-300]

HOT I

11002 0T **Ultra-thin super absorbing photon trapping materials for high-performance infrared detection** [11002-28]

11002 0U **Type II superlattices: HOT MWIR production and development at IRnova** [11002-30]

HOT II

11002 0W **Recombination processes in InAs/InAsSb type II strained layer superlattice MWIR nBn detectors (Invited Paper)** [11002-31]

11002 0X **GaSb grass as a novel antireflective surface for infrared detectors** [11002-32]

NIR / SWIR

11002 10 **Color discrimination of a short wave colorimeter** [11002-36]

11002 11 **InGaAs SWIR photodetectors for night vision** [11002-37]

11002 12 **MCT SWIR modules for active imaging** [11002-38]

11002 13 **Mesa pixel isolation with low dark current for improved MTF performance in SWIR photodiode array applications** [11002-39]

11002 14 **Low-capacitance InGaAs detectors for high-speed, wide field-of-view sensing applications** [11002-40]

11002 15 **The lowest cost and smallest footprint VGA SWIR detector with high performance** [11002-41]

HGCDTE

11002 16 **Improved high performance MCT MWIR and LWIR modules** [11002-42]

11002 17 **Discovering the difference: bispectral MCT-based detectors by AIM** [11002-43]

11002 18 **Dual waveband infrared detectors using MOVPE grown MCT** [11002-44]

11002 19 **Image quality improvement against the backdrop of SWAP and pitch reduction** [11002-45]

11002 1A **The status of LWIR MCT detector development at ASELSAN** [11002-46]

11002 1B **Comparing II-VI and III-V infrared detectors for space applications** [11002-47]

11002 1C **7.5µm and 5µm pitch IRFPA developments in MWIR at CEA-LETI** [11002-101]

IR IMAGING FOR AUTONOMOUS VEHICLES I

11002 1D **Development of far-infrared camera system for automotive (Invited Paper)** [11002-48]

IR IMAGING FOR AUTONOMOUS VEHICLES II

11002 1F **Automotive sensing: assessing the impact of fog on LWIR, MWIR, SWIR, visible, and lidar performance** [11002-50]

11002 1G **True 3D, angle resolved, ultrasensitive IR laser sensor for autonomous vehicles (Invited Paper)** [11002-51]

11002 1H **Thermal imaging for safer autonomous vehicles** [11002-52]

11002 1J **Shutterless far-infrared thermal camera for improving human identification robustness** [11002-54]

UNCOOLED FPAS AND APPLICATIONS

11002 1K **Elimination of unwanted modes in wavelength-selective uncooled infrared sensors using plasmonic metamaterial absorbers** [11002-55]

11002 1N **A novel approach to pyroelectric imaging** [11002-58]

11002 1O **ULIS bolometer improvements for fast imaging applications** [11002-59]

11002 1Q **A 160×120 LWIR-band CMOS Infrared (CIR) microbolometer** [11002-61]

SELECT APPLICATIONS

11002 1T **Molecular dynamics simulation of nerve agent-sorbent binding** [11002-64]

11002 1U **Mid-wavelength infrared resonant cavity enhanced photodiodes for infrared spectroscopic sensing of chemicals and other narrow-band optical signals** [11002-65]

VARIOUS ADVANCED DETECTOR DEVELOPMENTS I

11002 1W **Low SWaP video core for MWIR imaging** [11002-74]

11002 1X **High resolution SXGA InSb detector for long range sights** [11002-66]

11002 1Y **QWIPs are keeping their promises** [11002-67]

VARIOUS ADVANCED DETECTOR DEVELOPMENTS II

11002 21 **Subwavelength antimonide infrared detector coupled with dielectric resonator antenna** [11002-70]

11002 22 **Development of sub-10µm pitch HgCdTe infrared detectors** [11002-100]

11002 23 **High-responsivity graphene infrared photodetectors using photo-gating effect** [11002-71]

11002 24 **Multispectral graphene infrared photodetectors using plasmonic metasurfaces** [11002-72]

11002 25 **Novel photodetector design using open circuit voltage for mid-wave infrared imagers** [11002-73]

SMART PROCESSING

11002 27 **Infrared small target detection based on local contrast vector and signed normalization** [11002-76]

11002 28 **IR-FPA to miniaturized cameras: configurable chip implementing analog and digital data-processing blocks** [11002-77]

POSTER SESSION

11002 2A **Graphene-based Salisbury screen metasurfaces at infrared wavelengths** [11002-79]

11002 2B **A uniform micro-bump formation method using electroplating** [11002-80]

11002 2C **Development of shutter-less SOI diode uncooled IRFPA for compact size and low power consumption** [11002-81]

11002 2E **Barrier InAsSb/B-AlSb LWIR detector for FSO: theoretical assessment** [11002-83]

11002 2F **Fabrication of high aspect ratio bumps for focal plane arrays applications** [11002-84]

11002 2G **Detector characterization of a near-infrared discrete avalanche photodiode 5×5 array for astrophysical observations** [11002-85]

11002 2H **Algorithm for image stitching in the infrared** [11002-86]

11002 2I **Low frequency noise of mid-wavelength interband cascade photodetectors up to 300 K** [11002-87]

11002 2K **Ricor's new development of HOT cryocoolers: compact cost-effective linear model** [11002-89]

11002 2M **Ricor's advanced rotary cryocooler for HOT IR detectors** [11002-91]

Authors

Numbers in the index correspond to the last two digits of the seven-digit citation identifier (CID) article numbering system used in Proceedings of SPIE. The first five digits reflect the volume number. Base 36 numbering is employed for the last two digits and indicates the order of articles within the volume. Numbers start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B...0Z, followed by 10-1Z, 20-2Z, etc.

Abelson, L., 04
Abergel, J., 1C, 22
Adams, Arn, 07
Affouda, C. A., 0D
Aidam, R., 11
Aifer, E. H., 0D
Aina, Leye, 1G
Akar, Orhan S., 1Q
Akbulut, Mehmet, 1A
Akca, Esin, 1A
Akin, Tayfun, 1Q
Almqvist, S., 0U
Al-Saymari, F., 1U
Ames, Christopher, 17
Amouzegar, L., 04
Amparan, Gabriel A., 07
Anchlia, Ankur, 28
Aravazhi, Shanmugam, 0O
Arounassalame, V., 0E
Arts, R., 08
Asici, Burak, 1A
Bächle, A., 11
Bains, Sudesh, 18
Balit, E., 1J
Ball, Christopher, 21
Bartolo-Perez, Cesar, 0T
Barutcu, Berna, 1A
Baudry, X., 22
Becker, T., 10
Beech, Kim, 0M
Ben David, Oron, 2M
Benecke, M., 12
Bénière, A., 19
Benschop, T., 0A
Bercier, E., 1J
Bereznycky, Paul, 13, 2F
Berthoz, J., 19
Bewley, W. W., 0D
Bisotto, S., 1C, 22
Bonnefond, L., 22
Bonvalot, C., 15
Boudou, N., 1O
Bouvattier, J., 1J
Breiter, Rainer, 12, 16, 17
Bronner, W., 11
Brunner, A., 19
Budhu, Jordan, 21
Bundas, Jason, 0M
Burgess, L., 0P
Burrows, Doug, 0M
Caes, M., 0E
Canedy, C. L., 0D
Carlson, C., 04
Carmichael, M., 1U
Carmiel, Meir, 2M
Caro, Michael, 13, 2F
Cauquil, J.-M., 0A
Chapple, Samuel, 02
Chen, D., 1W
Chen, Shuhan, 27
Christol, P., 0E
Cilbir, Gorkem, 1Q
Ciura, Łukasz, 2I
Coleman, Thomas, 07
Colin, T., 15
Cologlu, Mustafa H, 1Q
Conrad, Ted, 02
Cooper, M. D., 0P
Cortial, S. 1O
Cosens, Maren, 2G
Costard, E., 0E, 0U, 1Y
Coussement, J., 15
Craig, A. P., 1U
Cueff, M., 1O
Dahiya, Vinita, 21
Danda, Tejaswi, 28
Daultier, Y., 15
Daumer, V., 0C
Dayanandha, M., 28
DeCuir, E. A., Jr., 0W
Dehzangi, Arash, 0G
Dennis, Rich, 0M
Devine, Ekaterina Ponizovskaya, 0T
DeWames, R. E., 0W
Dhar, Nibir K., 0T, 0W
Diel, W., 0U, 1Y
Dupont, B., 1C
Dupuy, J., 15
Durand, A., 1O
Durlin, Quentin, 0G
Edwards, Stuart A., 0M
Eich, Detlef, 12, 16, 17
Endicter, Scott P., 13, 2F
Eom, Jun Ho, 1X
Eroglu, H. Cuneyt, 1A
Erwin, Bart, 02
Evans, D., 1Y
Evans, Michael J., 13, 2F

Even, A., 22
Fantini, J., 15
Faska, Ross, 0M
Fastenau, Joel M., 0M, 0N
Fattala, S., 0U
Ferron, A., 1C
Fetters, Matt, 0M
Figgemeier, Heinrich, 12, 16, 17
Filis, Avishai, 2M
Fisher, Anita M., 0F, 0X
Fragasse, Roman, 25
Frasse-Sombet, S., 15
Fredin, L., 1U
Frey, Phillip, 0M, 0N
Fujisawa, D., 2C
Fukushima, Shoichiro, 23, 24, 2A
Fuller, Earl, 25
Furlong, Mark J., 0M, 0N, 0O, 0P
Garabédian, P., 15
Garcia, Edward, 02
Garcia, S., 08
Gazit, R., 1W
Gerken, M., 10
Gershon, G., 1W
Geske, Jon, 14
Ghandiparsi, Soroush, 0T
Giotta, D., 22
Golding, T. D., 1U
Gomółka, E., 2E
Gorecki, A., 1O
Gout, S., 22
Gover, Dan, 2K
Grabau, Martin, 02
Grangier, C., 22
Gravrand, O., 19
Grbic, Anthony, 21
Grossklaus, Kevin A., 21
Guénin, M., 0E
Guinedor, P., 19
Gunapala, Sarath D., 0F, 0X
Gustus, William J., 13
Hackiewicz, Klaudia, 2I
Haley, Darren, 02
Hanna, Stefan, 16, 17
Hanson, Charles M., 1N
Harant, O., 1J
Hata, H., 2C
Hellström, S., 1Y
Hill, Cory J., 0F
Hipwood, Les, 18
Höglund, L., 0E, 0U, 1Y
Hood, Andrew, 14
Houlihan, Sean, 13, 2F
Huang, Wei, 13, 2F
Im, Hyun Ja, 1X, 2B
Inceturkmen, Ercihan, 1A
Inoue, Koichi, 23, 24
Islam, M. Saif, 0T
Ivanov, R., 0U, 1Y
Jackson, E. M., 0D
Jamison, K., 1U
Jenkins, Geoffrey D., 1B
Jourdan, S., 19
Ju, Seong Hyeon, 1X
Judd, Kelsey M., 1F
Jung, Han, 1X, 2B
Kanai, Yasushi, 23
Karabchevsky, A., 1W
Kattner, Michael, 0M, 0N
Kazemi, Alireza, 21
Keo, Sam A., 0F, 0X
Kepenek, Reha, 1A
Khalil, Waleed, 25
Khoshakhlagh, Arezou, 0F, 0X
Kiblitski, Z., 1W
Kim, C. S., 0D
Kim, Kyung Heon, 2B
Kim, M., 0D
Kim, Nam Hwan, 1X, 2B
Kim, Sun Ho, 1X, 2B
Kim, Y., 1T
Kim, Young Chul, 1X
Kim, Young Ho, 1X, 2B
Kimata, Masafumi, 1K, 2A
Kirste, L., 0C
Klinger, V., 0C
Kolek, Andrzej, 2I
Kopytko, M., 2E
Kosasayama, Y., 2C
Krishna, Sanjay, 21, 25
Kumar, F. J., 0P
Lambrakos, S. G., 1T
LeBeau, Tim, 1H
Lee, Tae Hee, 1X
Li, Jiakai, 0G
Li, Siyang, 2G
Li, Xiaorun, 27
Lieb, Thad, 02
Ligtenberg, K., 08
Liobe, John, 13, 2F
Liu, Amy W. K., 0M, 0N
Logan, Julie V., 1B
Louvat, B., 1J
Lubyshev, Dmitri, 0M, 0N
Luong, Edward M., 0F
Lutz, Holger, 12, 16, 17
MacDougal, Michael, 14
Mackenzie, J., 0P
Maestas, Diana, 1B
Magen, O., 1W
Mahlein, Karl-Martin, 17
Mai, M., 09
Mailliart, O., 1C
Maire, Jérôme, 2G
Malchow, Doug, 13, 2F
Markovitz, T., 1W
Marshall, A. R., 1U
Martin, J.-Y., 0A
Martinez, Becky, 0N, 0O, 0P
Martyniuk, Piotr, 2E, 2I

Matsumoto, Kazuhiko, 23, 24
Maxey, Chris, 18
Mayet, Ahmed S., 0T
McClintock, Ryan, 0G
McEwen, R. Kennedy, 18
McGill, R. A., 1T
McHugh, Steve, 07
Meng, Fanfei, 0G
Merritt, C. D., 0D
Meyer, J. R., 0D
Mikołajczyk, J., 2E
Miramontes, Sergio, 02
Mittal, Saurabh, 28
Moore, John, 07
Morales, Manuel, 13, 2F
Morath, Christian P., 1B
Morgan, Aled O., 0M
Nachman, Ilan, 2K
Nacsa, L., 1J
Naureen, S., 0U
Nedelcu, A., 15
Nelson, Scott A., 0M, 0N
Nghiem, J., 0E
Nguyen, T., 04
Nicol, Fred, 07
Nicolas, J.-A., 1C
Niemasz, J., 0C, 11
Nishino, H., 0B
Nolde, J. A., 0D
Nussberger, M., 09
Nuzumlali, O. Lutfi, 1A
Obrecht, R., 22
Ogawa, Shinpei, 1K, 23, 24, 2A
Ohayon, R., 1W
Okuda, Satoshi, 23, 24, 2A
Ono, Takao, 23
Owton, Dan, 18
Ozaki, K., 0B
Ozgit-Akgun, Cagla, 1A
Ozturk, Hande, 1Q
Papantonakis, M. R., 1T
Paradis, Pablo, 21
Patnaude, Kelly, 0M
Pellerin, T., 22
Pelletier, S., 15
Pepper, Brian J., 0F, 0X
Péré-Laperne, N., 19
Petach, M., 04
Pozzi, M., 0U
Ptak, Piotr, 2I
Rabiee-Golgir, Hossein, 0T
Radchenko, Dmitry, 2K
Raf, Dror, 2K
Rafol, Sir B., 0F
Rapp, J., 09
Raviv, Zvika, 03
Raynal, G., 0A
Razeghi, Manijeh, 0G
Refaeli, Rami, 03
Rehm, R., 0C, 11
Reilly, J., 1U
Reisinger, Axel, 0M
Renet, S., 1C
Riabzev, Sergey, 1W, 2K, 2M
Ribet-Mohamed, I., 0E
Ricard, N., 19
Richards, Austin A., 1F
Rihtnesberg, D., 0U
Rizzo, Albert Skip, 0Q
Roberts, C. A., 1T
Rochette, F., 19, 1C, 22
Ronningen, Theodore J., 21, 25
Rosenhagen, C., 09
Rothman, J., 22
Rozenberg, O., 1W
Rozenshein, K., 1W
Rubaldo, L., 15, 19
Rühlich, I., 09
Russo, J., 04
Rutkowski, Jarosław, 2I
Rutz, F., 0C, 11
Ryu, Seong Min, 1X
San, Ayse, 1A
Santailler, J.-L., 1C, 22
Satake, T., 2C
Savich, G. R., 1U
Schallenberg, Timo, 17
Schlemmer, H., 10
Schuster, J., 0W
Segal, Victor, 2M
Sehlin, S., 1Y
Semenishchev, Evgenii, 2H
Shabaev, A., 1T
Sheahan, T., 0P
Shimatani, Masaaki, 23, 24, 2A
Shraifel, Igor, 2H
Shtrichman, I., 1W
Shu, Qingyuan, 21
Sieck, Alexander, 12, 17
Smith, Shane, 25
Smuk, A., 0U, 1Y
Smuk, S., 0U, 1Y
Sobol, Sergey, 2K
Soibel, Alexander, 0F, 0X
Son, Jung O., 1X, 2B
Specht, Teressa, 25
Stadelmann, T., 0C
Steenbergen, Elizabeth H., 1B
Sundaram, Mani, 0M
Suzuki, D., 2C
Suzuki, R., 0B
Syrel, N., 1W
Taghipour, Zahra, 21, 25
Takagawa, Yousuke, 1K
Takahashi, Jun, 1D
Takenaga, T., 2C
Takikawa, T., 2C
Tankut, Firat, 1Q
Tantawy, Ramy, 25
Tavori, Alon, 03

Thomas, Jeremy, 14
Thornton, Michael P., 1F
Ting, David Z., 0F
Tinnes, S., 1O
Tokita, Shigetoshi, 1D
Tolunguc, Alp, 1A
Tomasulo, S., 0D
Trybom, E., 0U
Tsunoda, K., 0B
Tumkaya, Umid, 1A
Tunca, Can, 1A
Vainshtein, Igor, 2M
Vandervelde, Thomas E., 21
Vasse, C., 08, 0A
Veprik, Alexander, 03
Virot, A., 1O
Vladovsky, I., 1W
Vojetta, G., 19
Voronin, Viacheslav, 2H
Vurgaftman, I., 0D
Walther, M., 0C
Wang, Devon, 13
Warren, M. V., 0D
Weber, A., 12
Weinstein, M., 1W
Wenisch, Jan, 17
Wicks, G. W., 1U
Wiegleb, R., 12
Wijewarnasuriya, Priyalal S., 0T
Willems, D., 08
Wise, Assaf, 03
Withopf, A., 09
Wörl, A., 0C
Wright, Shelley A., 2G
Wu, Donghai, 0G
Xia, Chaoqun, 27
Xu, Wei, 13
Yamashita, K., 2C
Yee, Karl Y., 0X
Yokoi, Satoru, 1D
Young, Steven M, 21
Zehctzer, Semeon, 03
Zehner, S., 09
Zelensky, Aleksandr, 2H
Zeng, Joe, 0M
Zhang, Wei, 13, 2F
Zhang, Yiyun, 0G
Zhao, Liaoying, 27
Zibold, A., 11
Zollner, Stefan, 21
Zumbro, E., 1T

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Ami Yaacobi, Rafael Advanced Defense Systems Ltd. (Israel)
Lucy Zheng, Institute for Defense Analyses (United States)
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Session Chairs

1 Cryogenic Cooling of Sensing Devices 2019: Cooler Design
Tonny Benschop, Thales Cryogenics B.V. (Netherlands)
Alexander Veprik, CRYO TECH Ltd., Gevasol (Israel)

2 Cryogenic Cooling of Sensing Devices 2019: Cooler Applications
Tonny Benschop, Thales Cryogenics B.V. (Netherlands)
Alexander Veprik, CRYO TECH Ltd., Gevasol (Israel)

3 T2SL I
Meimei Z. Tidrow, U.S. Army Night Vision & Electronic Sensors Directorate (United States)
Lucy Zheng, Institute for Defense Analyses (United States)
Manijeh Razeghi, Northwestern University (United States)

4 Conference Keynote
Bjørn F. Andresen, Consultant, Infrared Technologies & Applications (Israel)

5 T2SL II
Meimei Z. Tidrow, U.S. Army Night Vision & Electronic Sensors Directorate (United States)
Lucy Zheng, Institute for Defense Analyses (United States)
Linda Höglund, IRnova AB (Sweden)

6 HOT I
Michael T. Eismann, Air Force Research Laboratory (United States)
Sanjay Krishna, The Ohio State University (United States)

7 A Word from the Master
Gabor F. Fulop, Maxtech International, Inc. (United States) and Infrared Imaging News (United States)

8 HOT II
Michael T. Eismann, Air Force Research Laboratory (United States)
Sanjay Krishna, The Ohio State University (United States)

9 NIR / SWIR
John Liobe, Sensors Unlimited, a United Technologies Company (United States)
Martin H. Ettenberg, Princeton Infrared Technologies, Inc. (United States)

10 HgCdTe
Whitney Mason, DARPA (United States)
Laurent Rubaldo, SOFRADIR (France)

11 IR Imaging for Autonomous Vehicles I
John Lester Miller, Cascade Electro-Optics, LLC (United States)
Joseph G. Pellegrino, U.S. Army Night Vision & Electronic Sensors Directorate (United States)

12 IR Imaging for Autonomous Vehicles II
John Lester Miller, Cascade Electro-Optics, LLC (United States)
Joseph G. Pellegrino, U.S. Army Night Vision & Electronic Sensors Directorate (United States)

13 Uncooled FPAs and Applications
Kevin C. Liddiard, Electro-optic Sensor Design (Australia)
Masafumi Kimata, Ritsumeikan University (Japan)
Charles M. Hanson, SenseIR Solutions, LLC (United States)

14 Select Applications
R. Kennedy McEwen, Leonardo MW Ltd. (United Kingdom)
Mario O. Münzberg, HENSOLDT Optronics GmbH (Germany)

15 Various Advanced Detector Developments I
Rainer Breiter, AIM INFRAROT-MODULE GmbH (Germany)

16 Various Advanced Detector Developments II
Rainer Breiter, AIM INFRAROT-MODULE GmbH (Germany)

17 Smart Processing
John T. Caulfield, Cyan Systems, Inc. (United States)